Data sheet acquired from Harris Semiconductor SCHS236

ED74AC151 CD74ACT151

8-Input Multiplexer

September 1998

Features

- · Buffered Inputs
- Typical Propagation Delay
 - 6ns at $V_{CC} = 5V$, $T_A = 25^{\circ}C$, $C_L = 50pF$
- Exceeds 2kV ESD Protection MIL-STD-883, Method 3015
- SCR-Latchup-Resistant CMOS Process and Circuit Design
- Speed of Bipolar FAST™/AS/S with Significantly Reduced Power Consumption
- Balanced Propagation Delays
- AC Types Feature 1.5V to 5.5V Operation and Balanced Noise Immunity at 30% of the Supply
- ±24mA Output Drive Current
 - Fanout to 15 FAST™ ICs
 - Drives 50Ω Transmission Lines

Description

The CD74AC151 and CD74ACT151 are 8-input digital multiplexers that utilize the Harris Advanced CMOS Logic technology. They have three binary control inputs (S0, S1, and S2) and an active-LOW Enable $(\overline{\mathbb{E}})$ input. The three binary inputs select 1 of 8 channels. The output is both inverting (\overline{Y}) and non-inverting (Y).

Ordering Information

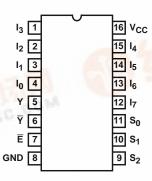
PART NUMBER	TEMP. RANGE (°C)	PACKAGE	PKG. NO.							
CD74AC151E	0 to 70°C, -40 to 85, -55 to 125	16 Ld PDIP	E16.3							
CD74ACT151E	0 to 70 ^o C, -40 to 85, -55 to 125	16 Ld PDIP	E16.3							
CD74AC151M96	0 to 70 ^o C, -40 to 85, -55 to 125	16 Ld SOIC	M16.15							
CD74ACT151M96	0 to 70°C, -40 to 85, -55 to 125	16 Ld SOIC	M16.15							

NOTES:

- 1. When ordering, use the entire part number. Add the suffix 96 to obtain the variant in the tape and reel.
- Wafer and die for this part number is available which meets all electrical specifications. Please contact your local sales office or Harris customer service for ordering information.

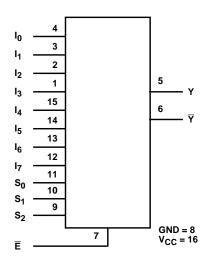
Pinout

CD74AC151, CD74ACT151 (PDIP, SOIC) TOP VIEW





Functional Diagram



TRUTH TABLE

INPUTS										OUT	PUTS		
Ē	S ₂	S ₁	S ₀	I ₀	I ₁	l ₂	l ₃	I ₄	l ₅	I ₆	I ₇	Ÿ	Y
Н	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Н	L
L	L	L	L	L	Х	Х	Х	Х	Х	Х	Х	Н	L
L	L	L	L	Н	Х	Х	Х	Х	Х	Х	Х	L	Н
L	L	L	Н	Х	L	Х	Х	Х	Χ	Х	Х	Н	L
L	L	L	Н	Х	Н	Х	Х	Х	Χ	Х	Х	L	Н
L	L	Н	L	Х	Х	L	Х	Х	Χ	Х	Х	Н	L
L	L	Н	L	Х	Х	Н	Х	Х	Х	Х	Х	L	Н
L	L	Н	Н	Х	Х	Х	L	Х	Χ	Х	Х	Н	L
L	L	Н	Н	Х	Х	Х	Н	Х	Х	Х	Х	L	Н
L	Н	L	┙	Х	Χ	Χ	Х	L	Χ	Х	Х	Н	L
L	Н	L	L	Х	Х	Х	Х	Н	Χ	Х	Х	L	Н
L	Н	L	Н	Х	Х	Х	Х	Х	L	Х	Х	Н	L
L	Н	L	Н	Х	Χ	Χ	Х	Х	Н	Х	Х	L	Н
L	Н	Н	L	Х	Х	Х	Х	Х	Х	L	Х	Н	L
L	Н	Н	L	Х	Х	Х	Х	Х	Х	Н	Х	L	Н
L	Н	Н	Н	Х	Х	Х	Х	Х	Х	Х	L	Н	L
L	Н	Н	Н	Х	Х	Х	Х	Х	Х	Х	Н	L	Н

H = HIGH voltage level, L = LOW voltage level, X = Don't Care

Absolute Maximum Ratings

DC Supply Voltage, V _{CC} 0.5V to 6V
DC Input Diode Current, I _{IK}
For $V_1 < -0.5V$ or $V_1 > V_{CC} + 0.5V$
DC Output Diode Current, I _{OK}
For $V_O < -0.5V$ or $V_O > V_{CC} + 0.5V$
DC Output Source or Sink Current per Output Pin, IO
For $V_O > -0.5V$ or $V_O < V_{CC} + 0.5V$
DC V _{CC} or Ground Current, I _{CC or} I _{GND} (Note 3) ±100mA

Thermal Information

Thermal Resistance (Typical, Note 5)	θ_{JA} ($^{o}C/W$)
PDIP Package	90
SOIC Package	160
Maximum Junction Temperature (Plastic Package)	150°C
Maximum Storage Temperature Range	65°C to 150°C
Maximum Lead Temperature (Soldering 10s)	300°C

Operating Conditions

Temperature Range, T _A
Supply Voltage Range, V _{CC} (Note 4)
AC Types1.5V to 5.5V
ACT Types
DC Input or Output Voltage, V _I , V _O 0V to V _{CO}
Input Rise and Fall Slew Rate, dt/dv
AC Types, 1.5V to 3V 50ns (Max)
AC Types, 3.6V to 5.5V
ACT Types, 4.5V to 5.5V

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTES:

- 3. For up to 4 outputs per device, add $\pm 25 \text{mA}$ for each additional output.
- 4. Unless otherwise specified, all voltages are referenced to ground.
- 5. $\theta_{\mbox{\scriptsize JA}}$ is measured with the component mounted on an evaluation PC board in free air.

DC Electrical Specifications

		TEST CONDITIONS		v _{cc}	25	oc.		C TO °C		C TO 5°C	
PARAMETER	SYMBOL	V _I (V)	I _O (mA)	(V)	MIN	MAX	MIN	MAX	MIN	MAX	UNITS
AC TYPES											
High Level Input Voltage	V _{IH}	-	-	1.5	1.2	-	1.2	-	1.2	-	V
				3	2.1	-	2.1	-	2.1	-	V
				5.5	3.85	-	3.85	-	3.85	-	V
Low Level Input Voltage	V _{IL}	-	-	1.5	-	0.3	-	0.3	-	0.3	V
				3	-	0.9	-	0.9	-	0.9	V
				5.5	-	1.65	-	1.65	-	1.65	V
High Level Output Voltage	V _{OH}	V _{IH} or V _{IL}	-0.05	1.5	1.4	-	1.4	-	1.4	-	V
			-0.05	3	2.9	-	2.9	-	2.9	-	V
			-0.05	4.5	4.4	-	4.4	-	4.4	-	V
			-4	3	2.58	-	2.48	-	2.4	-	V
			-24	4.5	3.94	-	3.8	-	3.7	-	V
			-75 (Note 6, 7)	5.5	-	-	3.85	-	-	-	V
			-50 (Note 6, 7)	5.5				-	3.85		V

DC Electrical Specifications (Continued)

		TEST CONDITIONS		V _{cc}	25	°C		C TO °C		C TO 5°C	
PARAMETER	SYMBOL	V _I (V)	I _O (mA)	(V)	MIN	MAX	MIN	MAX	MIN	MAX	UNITS
Low Level Output Voltage	V_{OL}	V _{IH} or V _{IL}	0.05	1.5	-	0.1	-	0.1	-	0.1	٧
			0.05	3	-	0.1	-	0.1	-	0.1	٧
			0.05	4.5	-	0.1	-	0.1	-	0.1	٧
			12	3	-	0.36	-	0.44	-	0.5	V
			24	4.5	-	0.36	-	0.44	-	0.5	V
			75 (Note 6, 7)	5.5	-	-	-	1.65	-	-	V
			50 (Note 6, 7)	5.5	-	-	-	-	-	1.65	V
Input Leakage Current	lį	V _{CC} or GND	-	5.5	-	±0.1	-	±1	-	±1	μА
Quiescent Supply Current MSI	Icc	V _{CC} or GND	0	5.5	-	8	-	80	-	160	μА
ACT TYPES											
High Level Input Voltage	V _{IH}	-	-	4.5 to 5.5	2	-	2	-	2	-	V
Low Level Input Voltage	V _{IL}	-	-	4.5 to 5.5	-	0.8	-	0.8	-	0.8	V
High Level Output Voltage	V _{OH}	V _{IH} or V _{IL}	-0.05	4.5	4.4	-	4.4	-	4.4	-	V
			-24	4.5	3.94	-	3.8	-	3.7	-	V
			-75 (Note 6, 7)	5.5	-	-	3.85	-	-	-	V
			-50 (Note 6, 7)	5.5	-	-	-	-	3.85	-	V
Low Level Output Voltage	V _{OL}	V _{IH} or V _{IL}	0.05	4.5	-	0.1	-	0.1	-	0.1	V
			24	4.5	-	0.36	-	0.44	-	0.5	V
			75 (Note 6, 7)	5.5	1	-	-	1.65	-	-	V
			50 (Note 6, 7)	5.5	-	-	-	-	-	1.65	V
Input Leakage Current	lį	V _{CC} or GND	-	5.5	-	±0.1	-	±1	-	±1	μА
Quiescent Supply Current MSI	Icc	V _{CC} or GND	0	5.5	-	8	-	80	-	160	μА
Additional Supply Current per Input Pin TTL Inputs High 1 Unit Load	Δl _{CC}	V _{CC} -2.1	-	4.5 to 5.5	-	2.4	-	2.8	-	3	mA

NOTES:

- 6. Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.
- 7. Test verifies a minimum 50Ω transmission-line-drive capability at 85° C, 75Ω at 125° C.

ACT Input Load Table

INPUT	UNIT LOAD
I (AII)	1
Ē	1
S	1

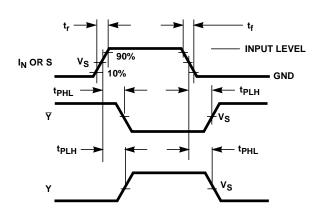
NOTE: Unit load is ΔI_{CC} limit specified in DC Electrical Specifications Table, e.g., 2.4mA max at 25°C.

Switching Specifications Input t_r , t_f = 3ns, C_L = 50pF (Worst Case)

			-40°C TO 85°C			-55	55°C TO 125°C		
PARAMETER	SYMBOL	V _{CC} (V)	MIN	TYP	MAX	MIN	TYP	MAX	UNITS
AC TYPES						-			
Propagation Delay,	t _{PLH} , t _{PHL}	1.5	-	-	152	-	-	169	ns
Any Data to Y		3.3 (Note 9)	4.9	-	17.1	4.7	-	18.9	ns
		5 (Note 10)	3.5	-	12.3	3.4	-	13.5	ns
Propagation Delay,	t _{PLH} , t _{PHL}	1.5	-	-	169	-	-	186	ns
Any Data to \overline{Y}		3.3	5.4	-	19	5.2	-	20.9	ns
		5	3.8	-	13.5	3.7	-	14.9	ns
Propagation Delay,	t _{PLH} , t _{PHL}	1.5	-	-	207	-	-	228	ns
Any Select to Y		3.3	6.6	-	23.2	6.4	-	25.5	ns
		5	4.7	-	16.5	4.6	-	18.2	ns
Propagation Delay,	t _{PLH} , t _{PHL}	1.5	-	-	223	-	-	245	ns
Any Select to \overline{Y}		3.3	7.1	-	24.9	6.9	-	27.4	ns
		5	5.1	-	17.8	4.9	-	19.6	ns
Propagation Delay,	t _{PLH} , t _{PHL}	1.5	-	-	139	-	-	153	ns
Any Enable to Y		3.3	4.4	-	15.5	4.3	-	17.1	ns
		5	3.1	-	11.1	3.1	-	12.2	ns
Propagation Delay,	t _{PLH} , t _{PHL}	1.5	-	-	153	-	-	169	ns
Any $\overline{\text{Enable}}$ to \overline{Y}		3.3	4.9	-	17.2	4.7	-	18.9	ns
		5	3.5	-	12.3	3.4	-	13.5	ns
Input Capacitance	Cl	-	-	-	10	-	-	10	pF
Power Dissipation Capacitance	C _{PD} (Note 11)	-	-	120	-	-	120	-	pF
ACT TYPES									
Propagation Delay, Any Data to Y	t _{PLH} , t _{PHL}	5 (Note 10)	4	-	14.1	3.9	-	15.5	ns
Propagation Delay, Any Data to \overline{Y}	t _{PLH} , t _{PHL}	5	4.4	-	15.4	4.2	-	16.9	ns
Propagation Delay, Any Select to Y	t _{PLH} , t _{PHL}	5	5.2	-	18.4	5.1	-	20.2	ns
Propagation Delay, Any Select to \overline{Y}	t _{PLH} , t _{PHL}	5	5.6	-	19.6	5.4	-	21.6	ns
Propagation Delay, Any Enable to Y	t _{PLH} , t _{PHL}	5	3.1	-	11	3	-	12.1	ns
Propagation Delay, Any Enable to Y	t _{PLH} , t _{PHL}	5	3.5	-	12.3	3.4	-	13.5	ns
Input Capacitance	Cl	-	-	-	10	-	-	10	pF
Power Dissipation Capacitance	C _{PD} (Note 11)	-	-	120	-	-	120	-	pF

NOTES:

- 8. Limits tested at 100%.
- 9. 3.3V Min at 3.6V, Max at 3V.
- 10. 5V Min at 5.5V, Max at 4.5V.
- 11. C_{PD} is used to determine the dynamic power consumption per device. AC: $P_D = V_{CC}^2 f_i (C_{PD} + C_L)$ ACT: $P_D = V_{CC}^2 f_i (C_{PD} + C_L) + V_{CC} \Delta I_{CC}$ where f_i = input frequency, C_L = output load capacitance, V_{CC} = supply voltage.





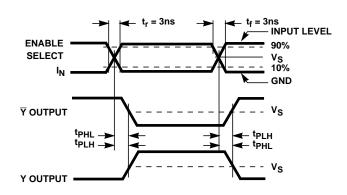
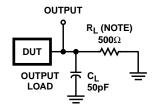


FIGURE 2. ENABLE TO OUTPUT PROPAGATION DELAYS



NOTE: For AC Series Only: When V_{CC} = 1.5V, R_L = 1k Ω .

	CD74AC	CD74ACT
Input Level	V _{CC}	3V
Input Switching Voltage, V _S	0.5 V _{CC}	1.5V
Output Switching Voltage, V _S	0.5 V _{CC}	0.5 V _{CC}

FIGURE 3. PROPAGATION DELAY TIMES

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